



Is Now Part of



ON Semiconductor®

**To learn more about ON Semiconductor, please visit our website at
www.onsemi.com**

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.



September 2010



FAN6747

Highly Integrated Green-Mode PWM Controller

Features

- High-Voltage Startup
- AC-Line Brownout Protection by HV Pin
- Constant Output Power Limit by HV Pin (Full AC-Line Range)
- Built-in 8ms Soft-Start Function
- Two-Level Over-Current Protection (OCP) with 220ms Debounce
- Short-Circuit Protection (SCP) with 15ms Debounce as Output Short
- Peak-Current Mode Operation with Cycle-by-Cycle Current Limiting
- Low Startup Current: 30 μ A
- Low Operating Current: 1.7mA
- Over-Temperature Protection (OTP) with an External Negative-Temperature-Coefficient (NTC) Thermistor
- PWM Frequency Decreasing at Green-Mode
- V_{DD} Over-Voltage Protection (OVP)
- Internal Latch Circuit for OVP, OTP, SCP, and OCP

Applications

General-purpose switch-mode power supplies and flyback power converters, including:

- Power Adapters
- SMPS with Peak-Current Output, such as for Printers, Scanners, Motor Drivers
- AC/DC NB Adapters
- Open-Frame SMPS

Description

The highly integrated FAN6747 PWM controller provides several features to enhance the performance of flyback converters. To minimize standby power consumption, a proprietary green-mode function provides off-time modulation to decrease the switching frequency with load condition.

Under zero-load condition, the power supply enters burst mode and burst frequency can be low to save more power. Green-mode function enables the power supply to meet international power conservation requirements.

The FAN6747 is especially designed for SMPS with peak-current output. It incorporates a cycle-by-cycle current limiting and two-level Over-Current-Protection (OCP) that can handle peak load with a debounce time. Once the current is over the threshold level, it triggers the first counter 15ms and checks if V_{DD} is below 10V; if it is, the PWM latches off for SCP. If V_{DD} is higher than 10V; it keeps counting to 220ms, then the PWM latches off for OCP.

FAN6747 also integrates a frequency-hopping function internally to help reduce EMI emission of a power supply with minimum line filters. Built-in proprietary internal synchronized slope compensation achieves constant output power limit over universal AC line range. The gate output is clamped at 14V to protect the external MOSFET from over-voltage damage.

Other protection functions include AC-line brownout protection with hysteresis and V_{DD} over-voltage protection. For over-temperature protection, an external NTC thermistor can be applied to sense the ambient temperature. When OCP, OVP, SCP, or OTP is activated, an internal latch circuit latches off the controller. The latch is reset when the V_{DD} supply is removed.

Ordering Information

Part Number	Operating Temperature Range	Package	Packing Method
FAN6747LMY	-40 to +105°C	8-Lead, Small-Outline Integrated Circuit (SOIC), JEDEC MS-012, .15-Inch Narrow Body	Tape & Reel

Application Diagram

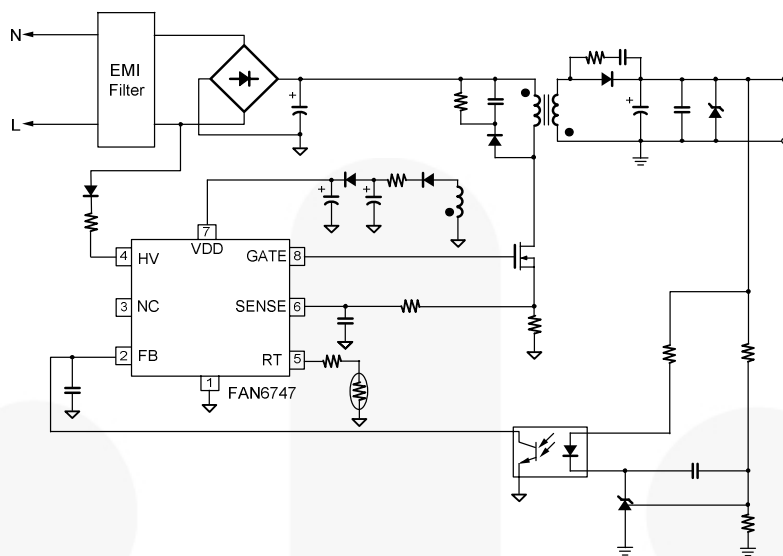


Figure 1. Typical Application

Internal Block Diagram

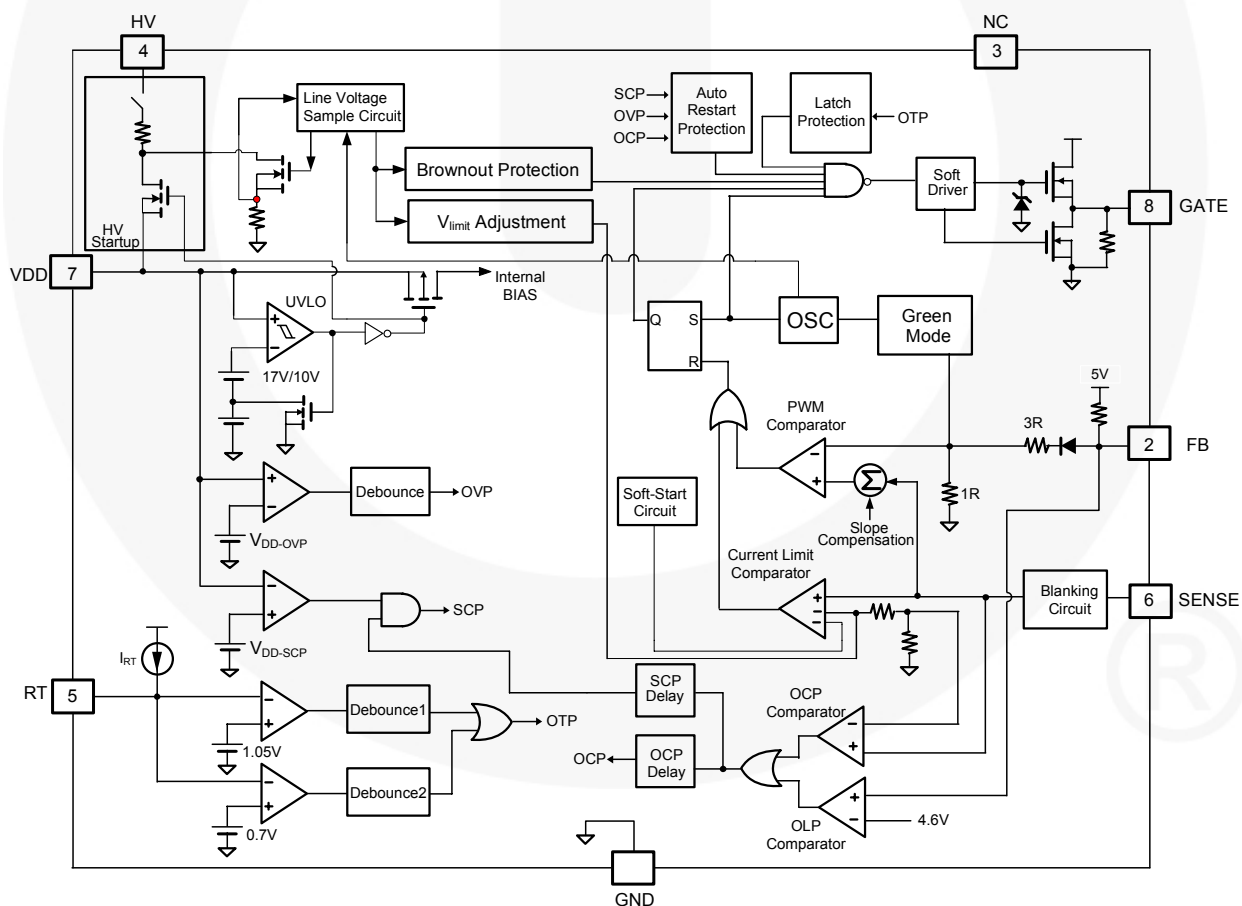
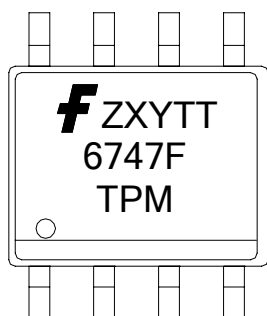


Figure 2. Functional Block Diagram

Marking Information



F: Fairchild Logo
Z: Plant Code
X: Year Code
Y: Week Code
TT: Die Run Code
F: L = OCP latch
T: Package Type (N = DIP, M = SOP)
P: Y = Green Compound
M: Manufacturing Flow Code

Figure 3. Top Mark

Pin Configuration

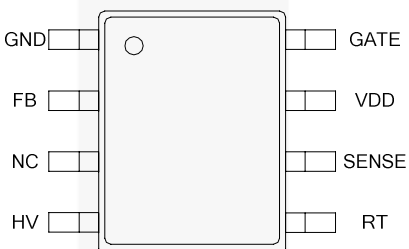


Figure 4. Pin Assignments

Pin Definitions

Pin #	Name	Description
1	GND	Ground. This pin is used for the ground potential of all the pins. A 0.1μF decoupling capacitor placed between VDD and GND is recommended.
2	FB	Feedback. The output voltage feedback information from the external compensation circuit is fed into this pin. The PWM duty cycle is determined from this pin and the current-sense signal from Pin 6.
3	NC	No Connection.
4	HV	High-Voltage Startup. This pin is connected to the line input via diodes and resistors to achieve brownout and high/low line compensation. Once the voltage of the HV pin is lower than the brownout voltage, PWM output is turned off. High/low line compensation dominates the OCP level and cycle-by-cycle current limit, to solves the unequal OCP level and power limit problem under universal input.
5	RT	Over-Temperature Protection. For over-temperature protection, an external NTC thermistor is connected from this pin to GND. The impedance of the NTC decreases at high temperatures. Once the voltage of the RT pin drops below the threshold voltage, the controller latches off the PWM. If the RT pin is not connected to the NTC resistor for over temperature protection, it is recommended to connect one 100KΩ resistor to ground to prevent noise interference. This pin is limited by internal clamping circuit.
6	SENSE	Current Sense. This pin is used to sense the MOSFET current for the current mode PWM and OCP. If the switching current is higher than OCP threshold and lasts 220ms, the controller latches off the PWM.
7	VDD	Supply Voltage. IC operating current and MOSFET driving current are supplied using this pin. This pin is connected to an external bulk capacitor of typically 10μF. The threshold voltages for startup and turn-off are 16.5V and 9V, respectively. The operating current is lower than 2mA.
8	GATE	Gate Driver Output. The totem-pole output driver for the power MOSFET. It is internally clamped below 14V.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit
V_{DD}	DC Supply Voltage		30	V
V_{HV}	Suddenly Input Voltage to HV Pin within 1 Second (Series connect with R_{HV})		640	V
V_L	Input Voltage to FB, SENSE, RT Pin	-0.3	7.0	V
P_D	Power Dissipation ($T_A < 50^\circ\text{C}$)		400	mW
θ_{JA}	Thermal Resistance (Junction-to-Ambient)		150	$^\circ\text{C/W}$
T_J	Operating Junction Temperature	-40	+125	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55	+150	$^\circ\text{C}$
T_L	Lead Temperature (Soldering, 10 Seconds)		+260	$^\circ\text{C}$
ESD	Electrostatic Discharge Capability, All Pins Except HV Pin	Human Body Model, JESD22-A114	4.50	kV
		Charge Device Model, JESD22-C101	1.5	

Notes:

1. Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device.
2. All voltage values, except differential voltages, are given with respect to the network ground terminal.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
T_A	Operating Ambient Temperature		-40		+105	$^\circ\text{C}$
V_{HV}	Input Voltage to HV Pin				500	V
R_{HV}	HV Startup Resistor		150	200	250	k Ω

Electrical Characteristics

$V_{DD}=15V$ and $T_A=25^\circ C$, unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
VDD Section						
V_{OP}	Continuously Operating Voltage				24	V
V_{DD-ON}	Turn-On Threshold Voltage		15.5	16.5	17.5	V
V_{DD-OFF}	PWM Turn-Off Threshold Voltage		8	9	10	V
V_{DD-OLP}	Threshold Voltage on V_{DD} for HV JFET Turn-On in Protection Condition	After Trigger OCP/SCP/ OVP/ OTP	5.5	6.5	7.5	V
V_{DD-LH}	Threshold Voltage on VDD Pin for Latch-Off Release Voltage		3.5	4.0	4.5	V
V_{DD-AC}	Threshold Voltage on VDD Pin for Disable AC Recovery to Avoid Startup Failed		$V_{DD-OFF} + 2.5$	$V_{DD-OFF} + 3.0$	$V_{DD-OFF} + 3.5$	V
V_{DD-SCP}	Threshold Voltage on VDD Pin for Short-Circuit Protection (SCP)	$V_{FB} > V_{FBO}$	$V_{DD-OFF} + 0.5$	$V_{DD-OFF} + 1.0$	$V_{DD-OFF} + 1.5$	V
I_{LH}	Holding Current Under Latch-Off Conduction	$V_{DD}=5V$	80	100	120	μA
I_{DD-ST}	Startup Current	$V_{DD-ON} - 0.16V$			30	μA
I_{DD-OLP}	Holding Current at PWM-Off Phase	$V_{DD-OLP} + 0.1V$	210	270	330	μA
I_{DD-OP1}	Operating Supply Current when PWM Operating	$V_{DD}=20V$, $V_{FB}=3V$ Gate Open		1.7	2.0	mA
I_{DD-OP2}	Operating Supply Current when PWM Stop	$V_{DD}=20V$, $V_{FB}=3V$ Gate Open		1.2	1.5	mA
V_{DD-OVP}	Threshold Voltage on VDD Pin for V_{DD} Over-Voltage Protection (Latch-Off)		24	25	26	V
t_{D-OVP}	V_{DD} OVP Debounce Time	$V_{FB} > V_{FB-N}$	75	160	245	μs

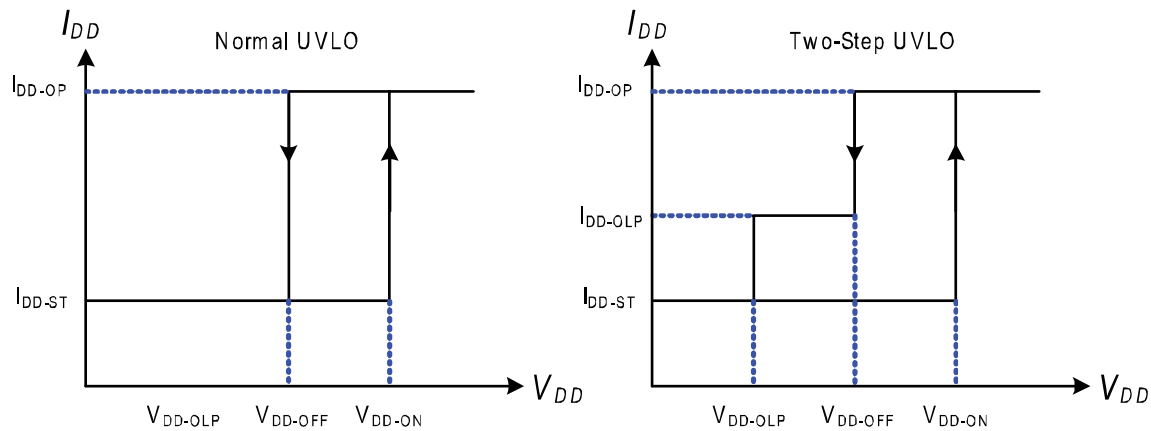


Figure 5. UVLO Specification

Continued on following pages...

Electrical Characteristics

$V_{DD}=15V$ and $T_A=25^{\circ}C$, unless otherwise specified.

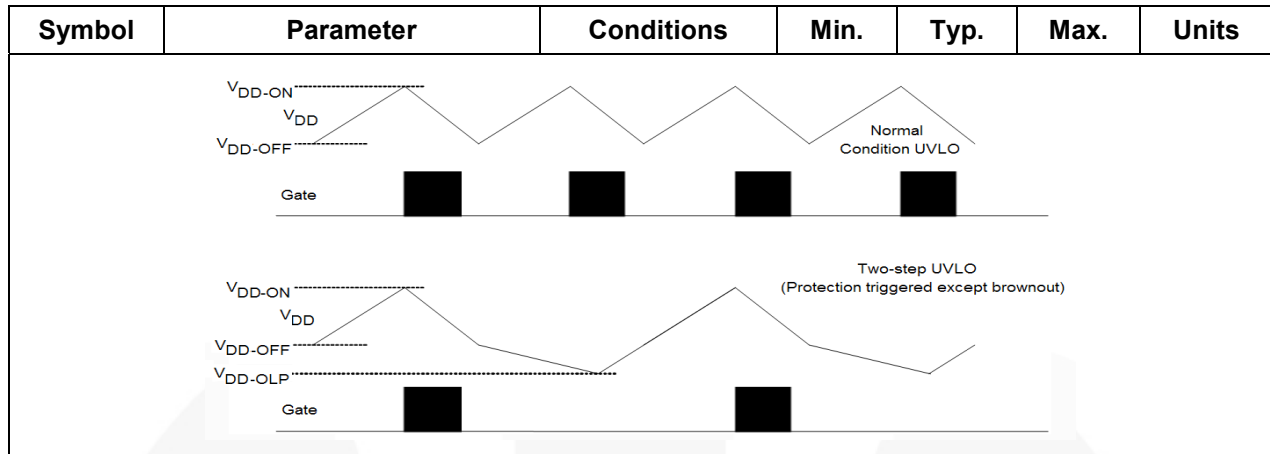


Figure 6. Normal UVLO and Two-Step UVLO Behavior

HV Section

I_{HV}	Supply Current Drawn from HV Pin	$V_{HV}=120V$, $V_{DD}=0V$	1.50	2.75	4.00	mA
V_{IN-OFF}	PWM Turn-Off Threshold	DC Source Series $R=200k$ to HV Pin	92	102	112	V
V_{IN-ON}	PWM Turn-On Threshold	DC Source Series $R=200k$ to HV Pin	104	114	124	V
ΔV_{IN}	Change in V_{IN} , $V_{IN-ON} - V_{IN-OFF}$	DC Source Series $R=200k$ to HV Pin	6	12	18	V
$t_{S-CYCLE}$	Line Voltage Sample cycle	$V_{FB} > V_{FB-N}$	170	205	240	μs
		$V_{FB} < V_{FB-G}$	450	615	780	
t_{S-TIME}	Line Voltage Sample Period			20		μs
$t_{D_VIN-OFF}$	PWM Turn-Off Debounce Time	$V_{FB} > V_{FB-N}$	65	75	85	ms
		$V_{FB} < V_{FB-G}$	180	235	290	ms

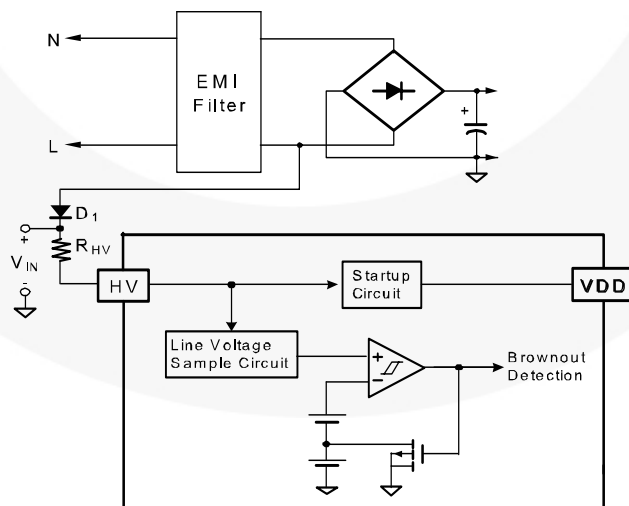


Figure 7. Brownout Circuit

Electrical Characteristics

$V_{DD}=15V$ and $T_A=25^{\circ}C$, unless otherwise specified.

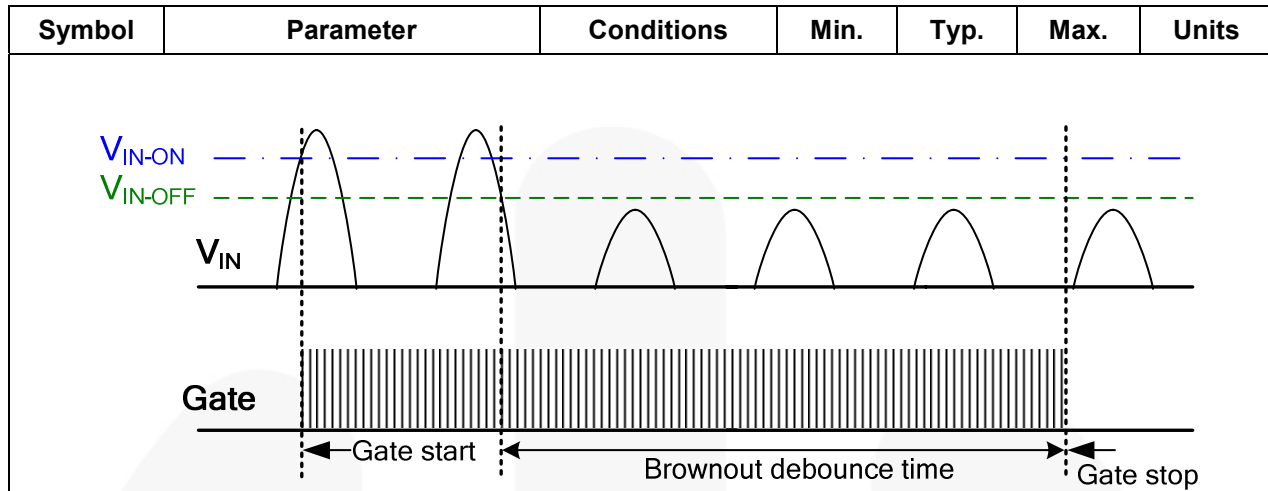


Figure 8. Brownout Behavior

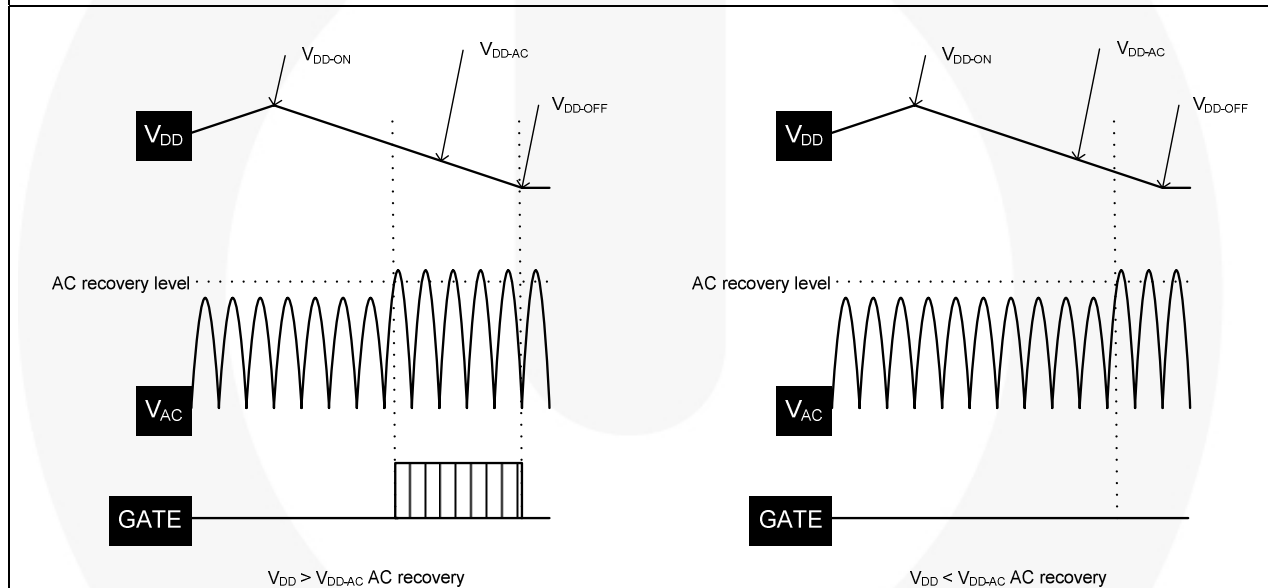


Figure 9. V_{DD-AC} and AC Recovery

Oscillator Section

f_{OSC}	Normal PWM Frequency	Center Frequency ($V_{FB} > V_{FB-N}$)	61	65	69	kHz
t_{JTR-1}	Jitter Period 1	$V_{FB} > V_{FB-N}$	3.9	4.4	4.9	ms
t_{JTR-3}	Jitter Period 3	$V_{FB} = V_{FB-G}$	10.2	11.5	12.8	ms
f_{OSC-G}	Green-Mode Minimum Frequency		19	22	25	kHz
V_{FB-N}	FB Threshold Voltage for Frequency Reduction Beginning	Pin, FB Voltage ($V_{FB} = V_{FB-N}$), $f_{OSC} - 5KHz$	2.6	2.8	3.0	V
		Jitter Range	± 3.7	± 4.2	± 4.7	kHz
V_{FB-G}	FB Threshold Voltage for Turn-Off Jitter and Frequency Reduction Destination	Pin, FB Voltage ($V_{FB} = V_{FB-G}$)	2.1	2.3	2.5	V
		Jitter Range		± 1.45		kHz

Electrical Characteristics

$V_{DD}=15V$ and $T_A=25^\circ C$, unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
V_{OZ-ON}	FB Threshold Voltage for Zero-Duty Recovery		1.6	1.8	2.0	V
V_{FB-ZDC} (V_{OZ-OFF})	FB Threshold Voltage for Zero-Duty		1.5	1.7	1.9	V
V_{OZ-ON} - V_{OZ-OFF}	FB Voltage Hysteresis for V_{OZ-ON} to V_{OZ-OFF}		50	100	150	mV
f_{DV}	Frequency Variation vs. V_{DD} Deviation	$V_{DD}=12V$ to $22V$			5	%
f_{DT}	Frequency Variation vs. Temperature Deviation	$T_A=-40$ to $105^\circ C$			5	%

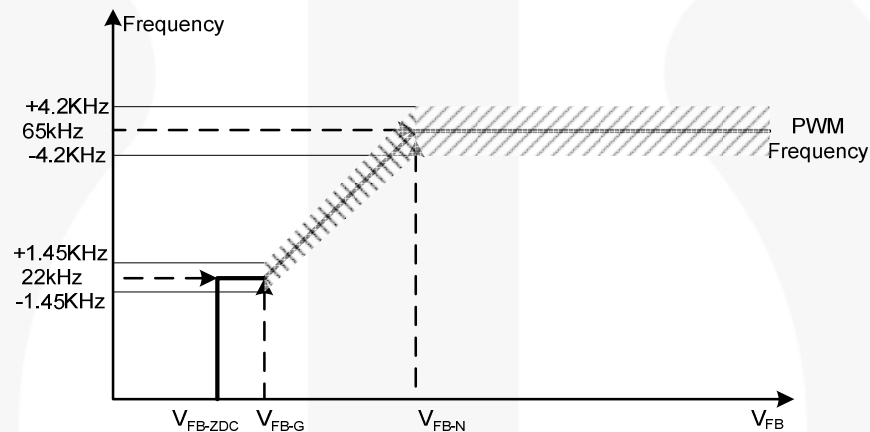


Figure 10. PWM Frequency

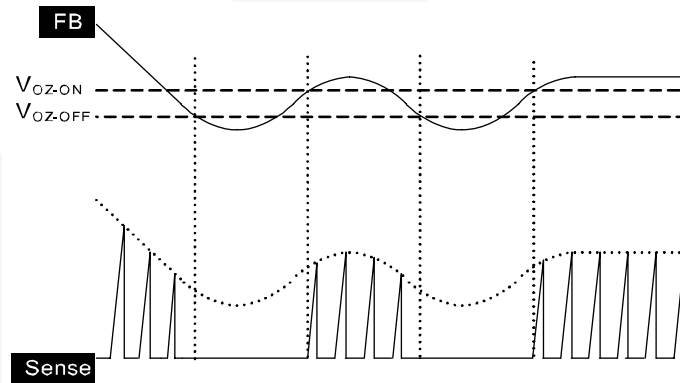


Figure 11. Burst-Mode Diagram

Feedback Input Section

A_v	Input-Voltage to Current-Sense Attenuation	$V_{FB} < V_{FB-G}$	1/4.5	1/4.0	1/3.5	V/V
Z_{FB}	Input Impedance		13.4	15.5	17.6	$k\Omega$
V_{FBO}	FB Pin Open Voltage		4.8	5.0	5.2	V
V_{FB-OLP}	FB Open-Loop Protection Threshold Voltage		4.3	4.6	4.9	V
t_{D-OLP}	Open-Loop Protection Debounce		190	215	240	ms

Electrical Characteristics

$V_{DD}=15V$ and $T_A=25^{\circ}C$, unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
Current Sense Section						
t_{PD}	Delay to Output			65	200	ns
t_{LEB}	Leading-Edge Blanking Time		230	270	310	ns
$V_{limit-L}$	Current Limit at Low Line ($V_{AC-RMS}=86V$)	$V_{DC}=122V$, Series $R=200k\Omega$ to HV	0.790	0.825	0.860	V
$V_{limit-H}$	Current Limit at High Line ($V_{AC-RMS}=259V$)	$V_{DC}=366V$, Series $R=200k\Omega$ to HV	0.690	0.725	0.760	V
V_{OCP-L}	OCP Trigger Level at Low Line ($V_{AC-RMS}=86V$)	$V_{DC}=122V$, Series $R=200k\Omega$ to HV	0.450	0.480	0.510	V
V_{OCP-H}	OCP Trigger Level at High Line ($V_{AC}=259V$)	$V_{DC}=366V$, Series $R=200k\Omega$ to HV	0.390	0.420	0.450	V
$t_{SOFT-START}$	Period During Startup	Startup Time	7	8	9	ms
t_{D-OCP}	Debounce Time for Output OCP	$V_{CS}>V_{OCP}$	190	215	240	ms
t_{D-SCP}	Debounce Time for Output SCP	$V_{CS}>V_{OCP}$ and $V_{DD}<V_{DD-SCP}$	12	15	18	ms
PWM Output Section						
DCY_{MAX}	Maximum Duty Cycle		88.0	89.5	91.0	%
V_{OL}	Output Voltage Low	$V_{DD}=15V$, $I_O=50mA$			1.5	V
V_{OH}	Output Voltage High	$V_{DD}=12V$, $I_O=50mA$	8			V
t_R	Rising Time	$GATE=1nF$		95		ns
t_F	Falling Time	$GATE=1nF$		30		ns
V_{CLAMP}	Gate Output Clamping Voltage	$V_{DD}=22V$	11.0	13.5	16.0	V
Over-Temperature Protection Section						
I_{RT}	Output Current of RT Pin		92	100	108	μA
$V_{OTP-LATCH-OFF}$	Threshold Voltage for Over-Temperature Protection		1.00	1.05	1.10	V
$t_{D_OTP-LATCH}$	Over-Temperature Latch-Off Debounce	$V_{FB} > V_{FB-N}$	14	16	18	ms
		$V_{FB} < V_{FB-G}$	40	51	62	ms
$V_{OTP2-LATCH-OFF}$	Second Threshold Voltage for Over-Temperature Protection		0.65	0.70	0.75	V
$t_{D_OTP2-LATCH}$	Second Over-Temperature Latch-Off Debounce	$V_{FB} > V_{FB-N}$	110	185	260	μs
		$V_{FB} < V_{FB-G}$	320	605	890	

Typical Performance Characteristics

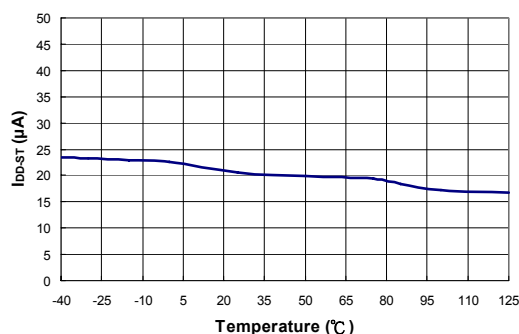


Figure 12. Startup Current (I_{DD-ST}) vs. Temperature

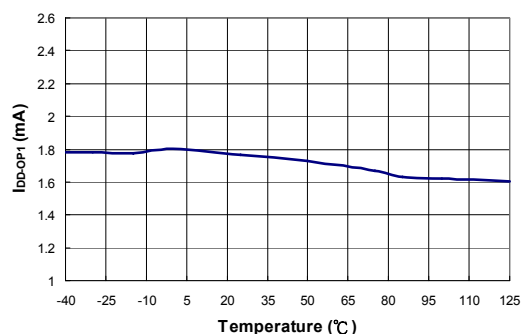


Figure 13. Operation Supply Current (I_{DD-OP1}) vs. Temperature

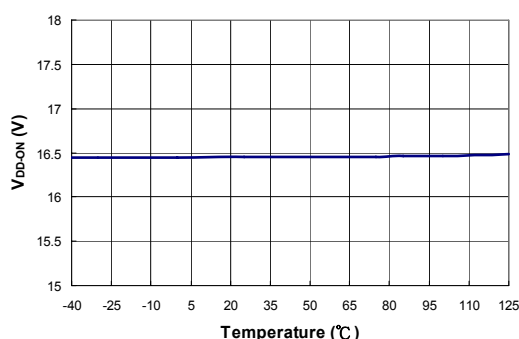


Figure 14. Start Threshold Voltage (V_{DD-ON}) vs. Temperature

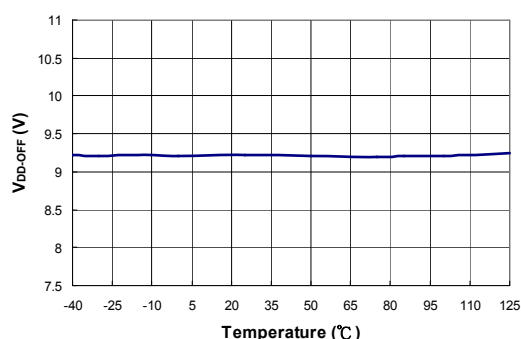


Figure 15. Minimum Operating Voltage (V_{DD-OFF}) vs. Temperature

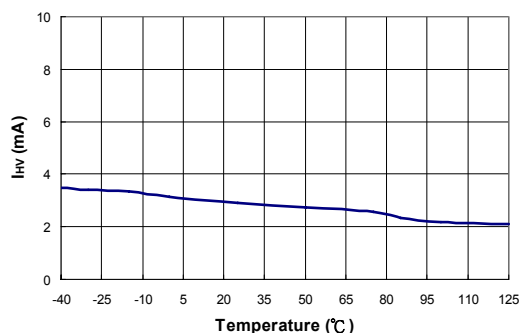


Figure 16. Supply Current Drawn from HV Pin (I_{HV}) vs. Temperature

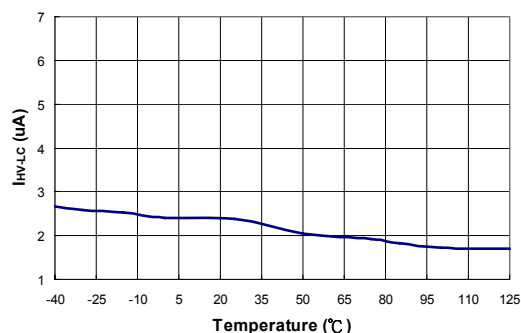


Figure 17. HV Pin Leakage Current After Startup (I_{HV-LC}) vs. Temperature

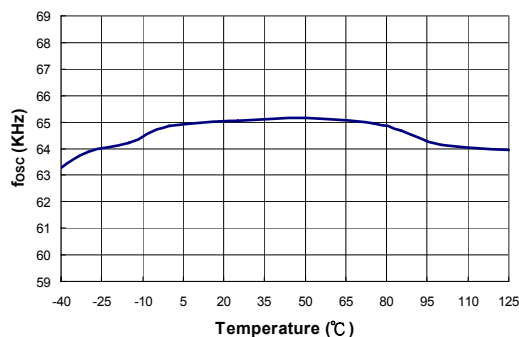


Figure 18. Frequency in Normal Mode (f_{OSC}) vs. Temperature

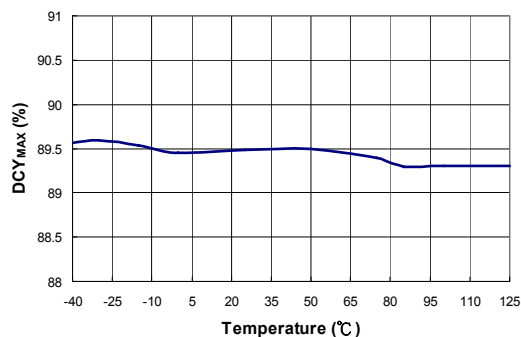


Figure 19. Maximum Duty Cycle (DCY_{MAX}) vs. Temperature

Typical Performance Characteristics

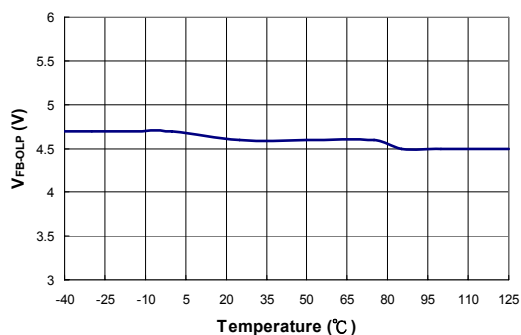


Figure 20. FB Open-Loop Trigger Level (V_{FB-OLP}) vs. Temperature

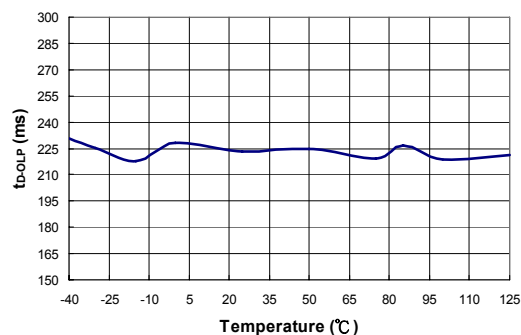


Figure 21. Debounce Time of FB Pin Open-Loop Protection (t_{D-OLP}) vs. Temperature

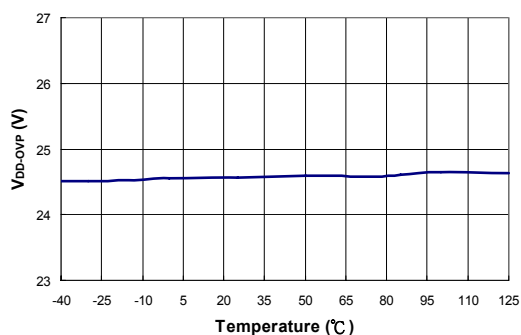


Figure 22. V_{DD} Over-Voltage Protection (V_{DD-OVP}) vs. Temperature

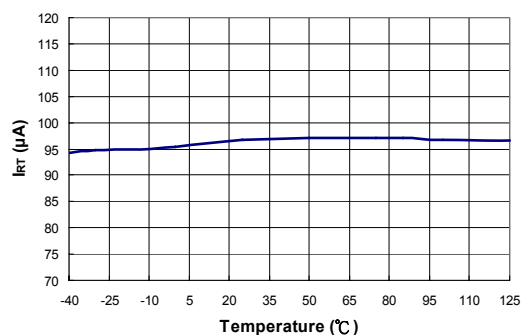


Figure 23. Output Current from RT Pin (I_{RT}) vs. Temperature

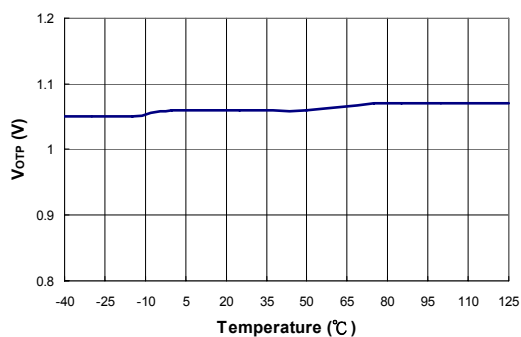


Figure 24. Over-Temperature Protection Threshold Voltage (V_{OTP}) vs. Temperature

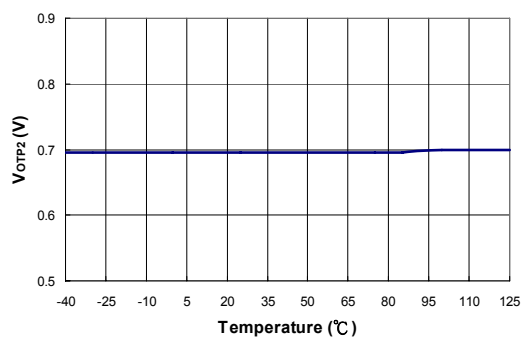


Figure 25. Over-Temperature Protection Threshold Voltage (V_{OTP2}) vs. Temperature

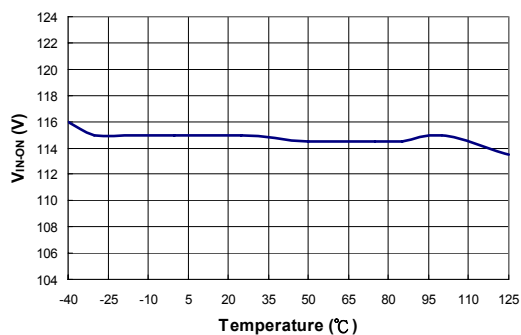


Figure 26. Brown-In (V_{IN-ON}) vs. Temperature

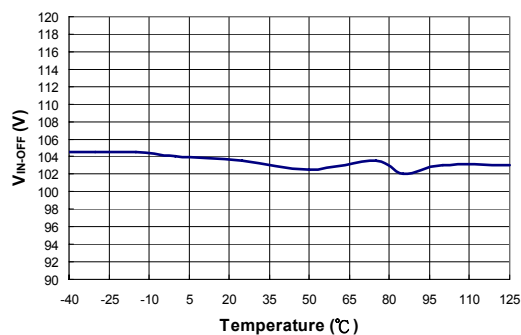


Figure 27. Brownout (V_{IN-OFF}) vs. Temperature

Operation Description

Startup Current

For startup, the HV pin is connected to the line input through an external diode and resistor, R_{HV} , (1N4007 / 200K Ω recommended). Peak startup current drawn from the HV pin is $(V_{AC} \times \sqrt{2})/R_{HV}$ and charges the hold-up capacitor through the diode and resistor. When the V_{DD} capacitor level reaches V_{DD-ON} , the startup current switches off. At this moment, the V_{DD} capacitor only supplies the FAN6747 to maintain the V_{DD} before the auxiliary winding of the main transformer provides the operating current.

Operating Current

Operating current is around 2mA. The low operating current enables better efficiency, power saving, and reduces the requirement of V_{DD} hold-up capacitance.

Green-Mode Operation

The proprietary green-mode function provides off-time modulation to reduce the switching frequency in light-load and no-load conditions. V_{FB} , which is derived from the voltage feedback loop, is taken as the reference. Once V_{FB} is lower than the threshold voltage, switching frequency is continuously decreased to the minimum green-mode frequency of around 22KHz.

Two-Level Over-Current Protection (OCP)

The cycle-by-cycle current limiting shuts down the PWM immediately when the sense voltage is over the limited threshold voltage (0.825V at low line). Additionally, when the sense voltage is higher than the OCP threshold (0.48V at low line), the internal counter counts for 220ms, then latches off PWM. When OCP occurs, PWM output is turned off and V_{DD} begins decreasing.

When V_{DD} goes below the turn-off threshold (~9V), the controller is totally shut down. V_{DD} continues to discharge below V_{DD-OLP} by I_{DD-OLP} . Then V_{DD} is charged up to the turn-on threshold voltage of 16.5V through the startup resistor. When V_{DD} is charged to 16.5V, it cycles again. This phenomenon is called two-level UVLO.

Brownout and Constant Power Limited HV Pin

Unlike previous PWM controllers, FAN6747's HV pin isn't only used for startup; it can also detect the AC line voltage to perform brownout function and set the current limit level. Through a fast diode and startup resistor to sample the AC line voltage, the peak value refreshes and stores in register at each sampling cycle. When internal update time is met, this peak value is used to for brownout and current-limit level judgment. Equations 1 and 2 can be used to calculate out the level of brown-in or brownout converted to RMS value. For power saving, FAN6747 enlarges the sampling cycle to lower the power loss from HV sampling at light-load condition.

$$V_{AC-ON}(RMS) = (0.9 \times \frac{R_{HV} + 1.6}{1.6}) / \sqrt{2} \quad (1)$$

$$V_{AC-OFF}(RMS) = (0.81 \times \frac{R_{HV} + 1.6}{1.6}) / \sqrt{2} \quad (2)$$

; the unit of R_{HV} is k Ω

Short-Circuit Protection (SCP)

This protection is used to handle the huge output demand if the power supply output is suddenly shorted to ground. If V_{DD} drops under 10V and the sensed voltage is higher than the limited threshold voltage, SCP is triggered and PWM output is latched off. This latch condition is reset only if V_{DD} is discharged under 4V or by unplugging AC power line.

Under-Voltage Lockout (UVLO)

The turn-on and turn-off thresholds are fixed internally at 16.5V and 9V, respectively. During startup, the hold-up capacitor must be charged to 16.5V through the startup resistor to enable the IC. The hold-up capacitor continues to supply V_{DD} before the energy can be delivered from auxiliary winding of the main transformer. V_{DD} must not drop below 9V during startup. This UVLO hysteresis window ensures that the hold-up capacitor is adequate to supply V_{DD} during startup.

Leading-Edge Blanking (LEB)

Each time the power MOSFET is switched on, a turn-on spike occurs on the sense-resistor. To avoid premature termination of the switching pulse, a leading-edge blanking time is built in. During this blanking period, the current-limit comparator is disabled and can not switch off the gate driver.

Gate Output / Soft Driving

The BiCMOS output stage is a fast totem-pole gate driver. Cross conduction has been avoided to minimize heat dissipation, increase efficiency, and enhance reliability. The output driver is clamped by an internal 13.5V Zener diode to protect power MOSFET transistors against undesirable gate over voltage. A soft driving waveform is implemented to minimize EMI.

V_{DD} Over-Voltage Protection (OVP)

V_{DD} over-voltage protection is built in to prevent damage due to abnormal conditions. If the V_{DD} voltage is over the over-voltage protection voltage (V_{DD-OVP}) and lasts for t_{D-OVP} , the PWM pulses are disabled until the V_{DD} voltage drops below 4V, then restarts again.

Soft-Start

For many applications, it is necessary to minimize the inrush current at startup. The built-in 8ms soft-start circuit significantly reduces the startup current spike and output voltage overshoot.

Built-In Slope Compensation

The sensed voltage across the current-sense resistor is used for peak-current-mode control and pulse-by-pulse current limiting. Built-in slope compensation improves stability and prevents sub-harmonic oscillation. FAN6747 inserts a synchronized, positive-going, ramp at every switching cycle.

Constant Output Power Limit

When the SENSE voltage across sense resistor R_S reaches the threshold voltage, the output GATE drive is turned off after a small delay, t_{PD} . This delay introduces an additional current proportional to $t_{PD} \cdot V_{IN} / L_P$. Since the delay is nearly constant regardless of the input voltage V_{IN} , higher input voltage results in a larger additional current and the output power limit is higher than under low input line voltage. To compensate this variation for a wide AC input range, a power-limiter is controlled by HV pin to solve the unequal power-limit problem. The power limiter is fed to the inverting input of the OCP comparator. This results in a lower current limit at high-line input than at low-line input.

Over-Temperature Protection (OTP)

A NTC thermistor, R_{NTC} , in series with a resistor, R_A , is connected from the RT pin to GND pin. A constant current I_{RT} is output from this pin. The voltage of the RT pin can be expressed as $V_{RT} = I_{RT} \cdot (R_{NTC} + R_A)$, where I_{RT} is 100 μ A, the headroom of V_{RT} is limited at around 5V by internal circuitry. As high ambient temperatures occur, R_{NTC} is smaller, such that the V_{RT} decreases. When V_{RT} is less than 1.05V(V_{OTP}) but over 0.7V, the PWM turns off after $t_{D_OTP-LATCH}$. The other threshold, V_{DD} under 0.7V, is used for fast shut down of FAN6747 after a short time. If the RT pin is not connected to the NTC resistor for over temperature protection, it is recommended to connect one 100K Ω resistor to ground to prevent noise interference. This pin is limited by internal clamping circuit.

Noise Immunity

Noise on the current sense or control signal may cause significant pulse-width jitter, particularly in continuous-conduction mode. Slope compensation helps alleviate this problem. Good placement and layout practices should be followed. Avoiding long PCB traces and component leads, locating compensation and filter components near the FAN6747, and increasing the power MOS gate resistance improve performance.

Physical Dimensions

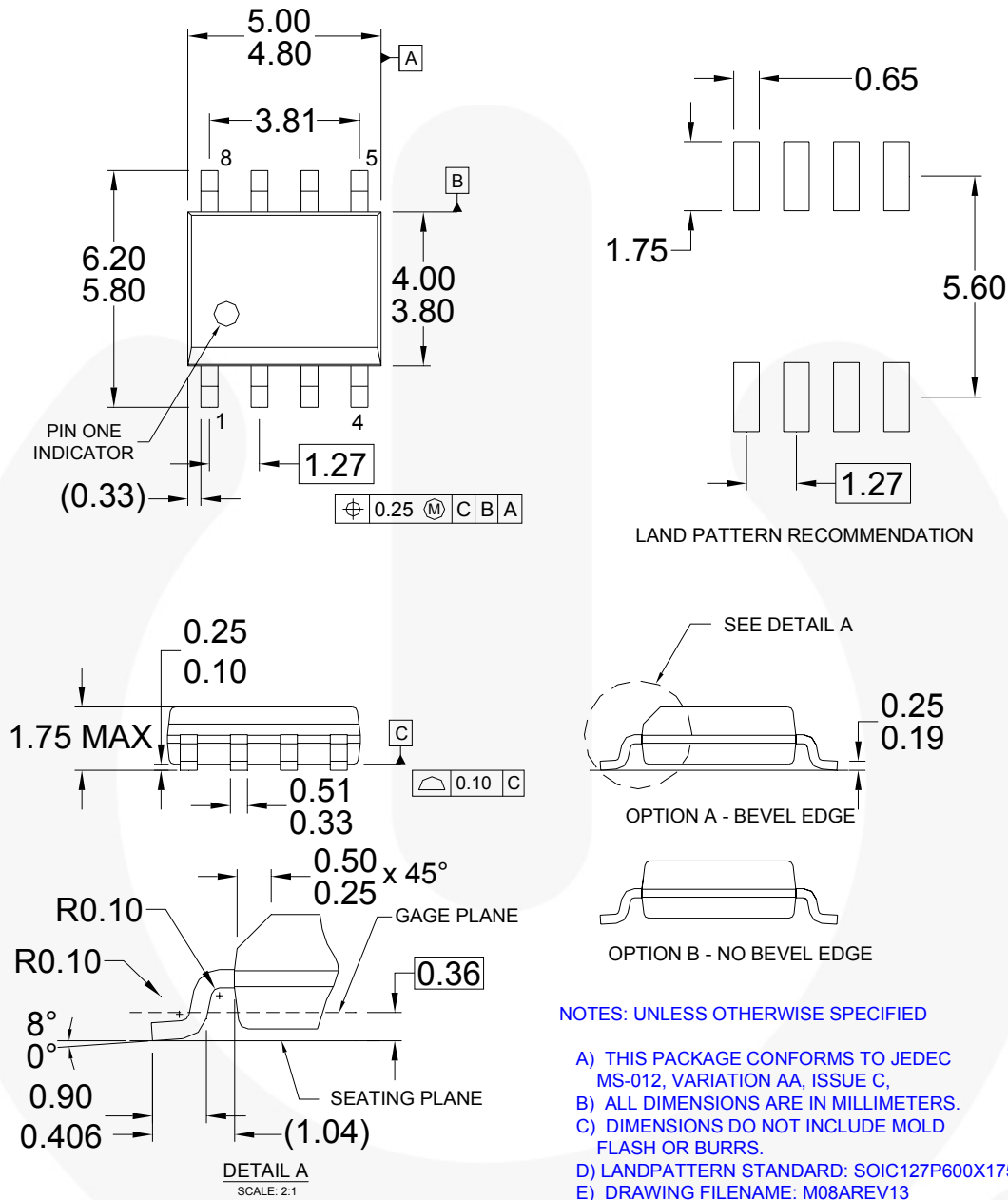


Figure 28. 8-Lead, Small Outline Integrated Circuit (SOIC) Package

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

<http://www.fairchildsemi.com/packaging/>

**TRADEMARKS**

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™
Auto-SPM™
Build it Now™
CorePLUS™
CorePOWER™
CROSSVOLT™
CTL™
Current Transfer Logic™
DEUXPEED®
Dual Cool™
EcoSPARK®
EfficientMax™
ESBC™
F[®]
Fairchild®
Fairchild Semiconductor®
FACT Quiet Series™
FACT®
FAST®
FastvCore™
FETBench™
FlashWriter®
FPS™

F-PFS™
FRFET®
Global Power ResourceSM
Green FPS™
Green FPS™ e-Series™
Gmax™
GTO™
IntelliMAX™
ISOPANAR™
MegaBuck™
MICROCOUPLER™
MicroFET™
MicroPak™
MicroPak2™
MillerDrive™
MotionMax™
Motion-SPM™
OptoHIT™
OPTOLOGIC®
OPTOPLANAR®
PDP SPM™

Power-SPM™
PowerTrench®
PowerXS™
Programmable Active Droop™
QFET®
QST™
Quiet Series™
RapidConfigure™
Saving our world, 1mW/Wk/W at a time™
SignalWise™
SmartMax™
SMART START™
SPM®
STEALTH™
SuperFET®
SuperSOT™-3
SuperSOT™-6
SuperSOT™-8
SupreMOS®
SyncFET™
Sync-Lock™

SYSTEM[®]
GENERAL[®]
The Power Franchise®
the power franchise
TinyBoost™
TinyBuck™
TinyCalc™
TinyLogic®
TINYOPTO™
TinyPower™
TinyPWM™
TinyWire™
TriFault Detect™
TRUECURRENT™*
µSerDes™
SerDes[®]
UHC®
Ultra FRFET™
UniFET™
VCX™
VisualMax™
XST™

* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS**Definition of Terms**

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I50

ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free
USA/Canada

Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910

Japan Customer Focus Center
Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: <http://www.onsemi.com/orderlit>

For additional information, please contact your local
Sales Representative